

Operation of MMCs with Dynamic Temperature-Dependent Current Limits

Manchester Electrical Energy and Power Systems
Workshop

Jorge Gonçalves,
D. J. Rogers and J. Liang



07-11-14

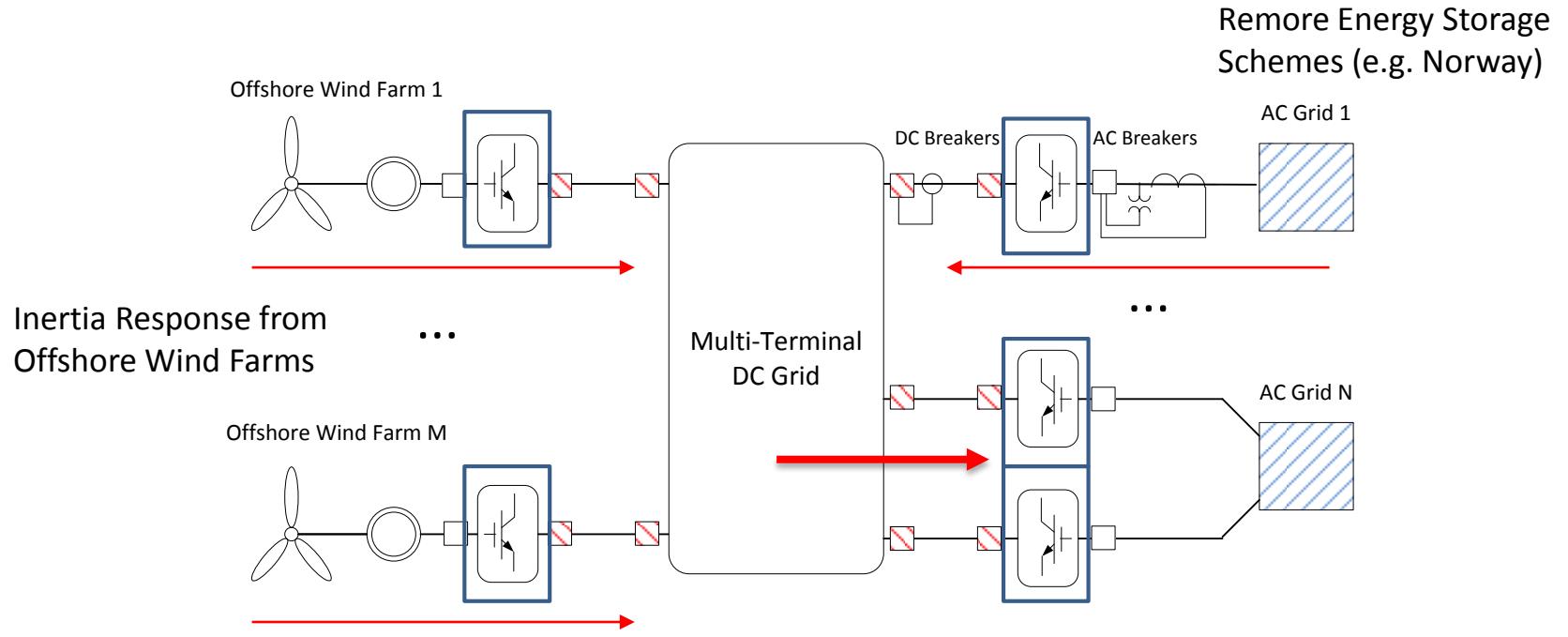


Outline

- Modular Multilevel Converter:
 - Structure and Control
 - Limits and Constraints
 - Electro-Thermal Model
 - Dynamic Temperature-Dependent Current Limits
- Case Study
- Results
- Conclusions & Future Work



Big Picture...

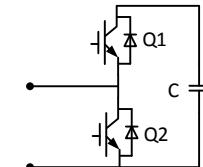
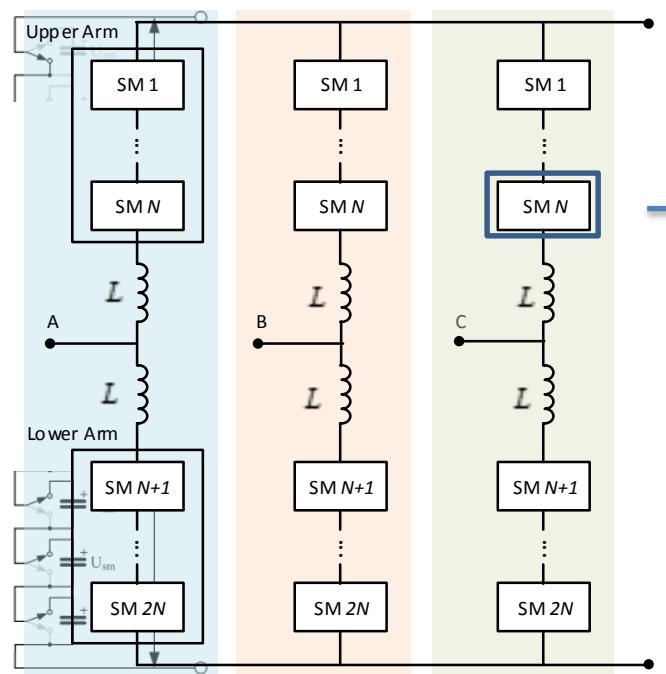
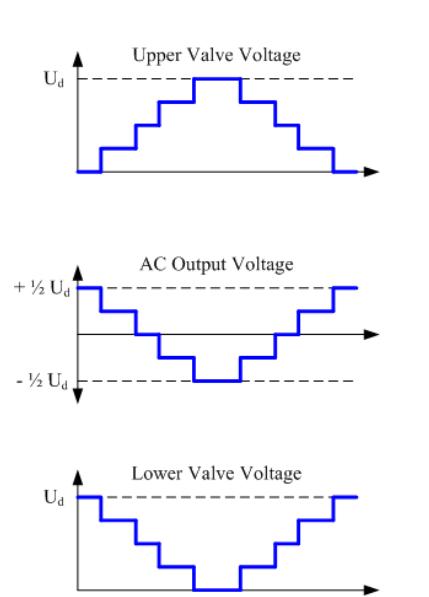


Under power unbalance conditions, additional transmision capability might be necessary.

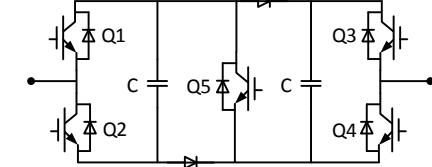


Modular Multilevel Converter

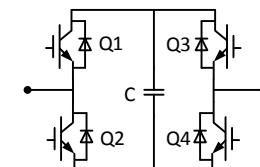
- Structure and Operation



Half-Bridge



Clamp Double

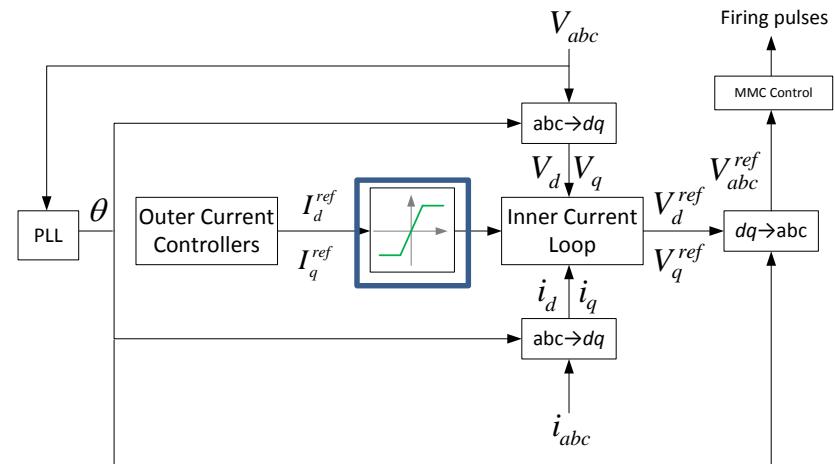
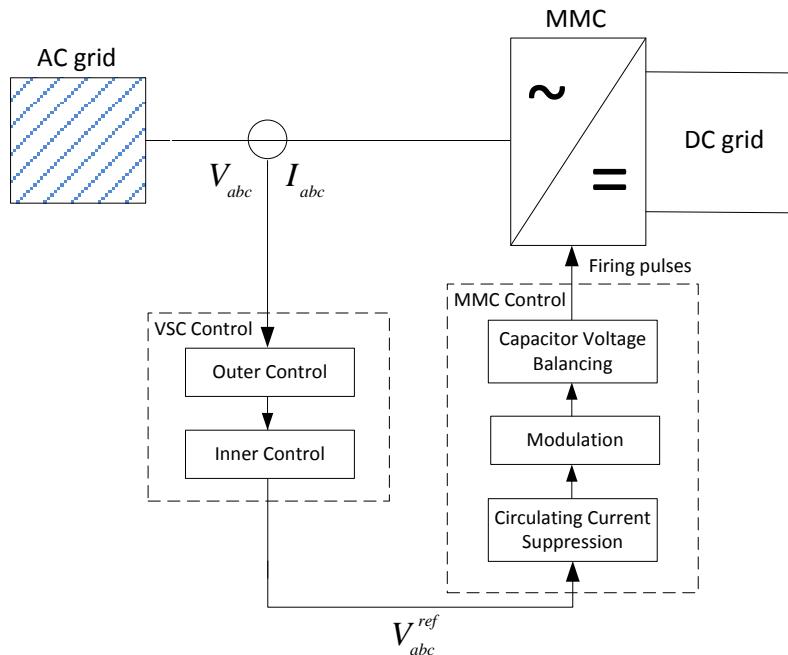


Full Bridge



Modular Multilevel Converter

- Control ($dq0$ reference frame)



- Fixed limits set the maximum power contribution from the converter
- Must ensure that thermal limits are not exceeded



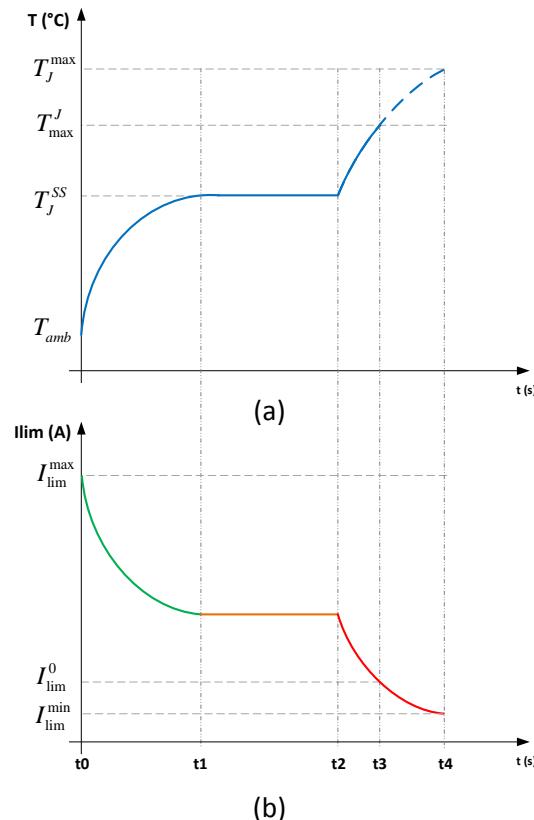
Modular Multilevel Converter

- Limits and Constraints
 - Besides electrical, semiconductors have strict thermal limits that must be respected;
 - A more robust control system must ensure that the necessary constraints are respected, **without limiting the transmission capacity**;
 - In this work a combined approach is proposed, where the current limits are sensitive to the temperature dynamics in the semiconductors.

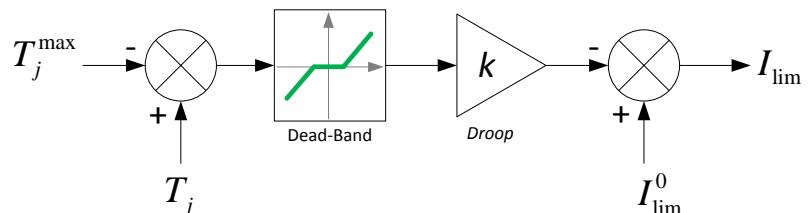


MMC Electro-Thermal Model

Dynamic Temperature-Dependent Current Limits



$$I_{\text{lim}}(T_J) = I_{\text{lim}}^0 + k(T_{\text{max}}^J - T_J)$$



MMC Electro-Thermal Model

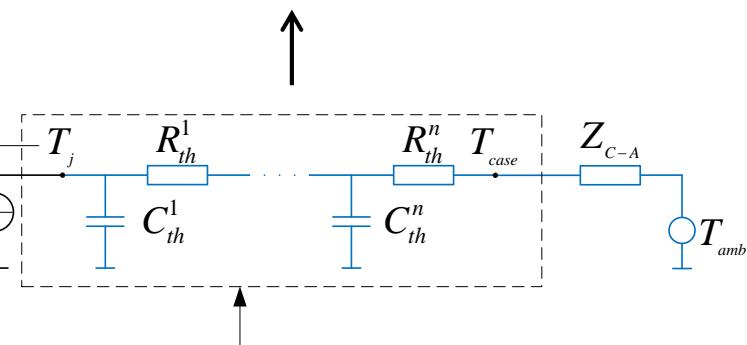
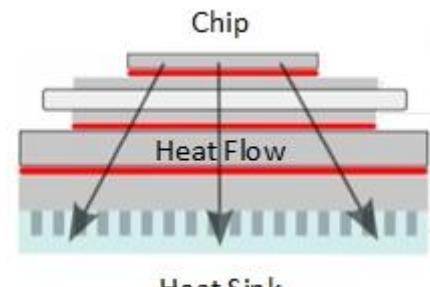
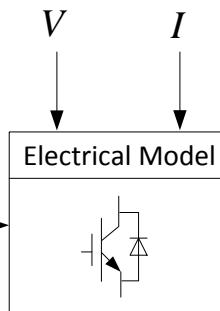
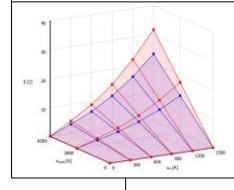
IGBT Module
Data Sheet



Curve Extraction

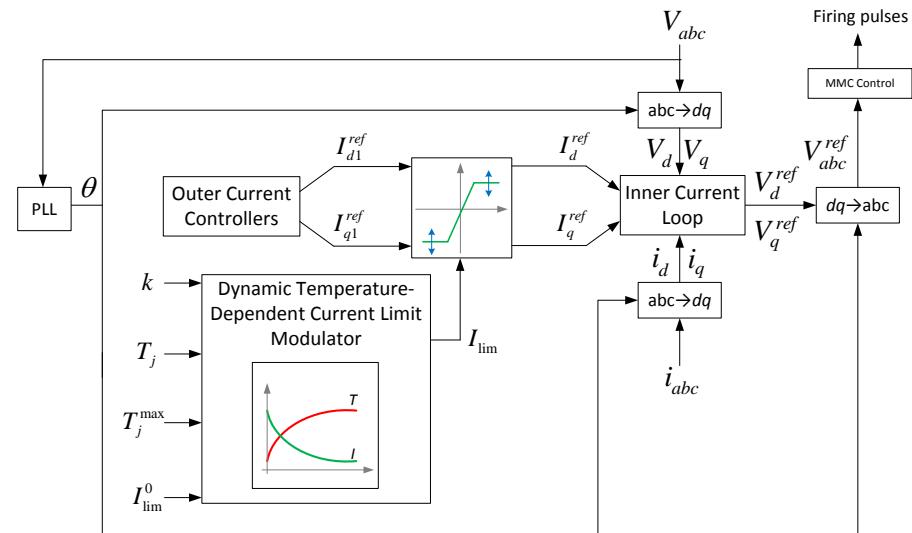
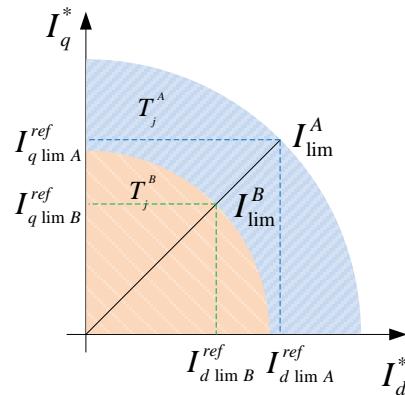
Curve Fitting (LS)

Thermal Description



MMC Electro-Thermal Model

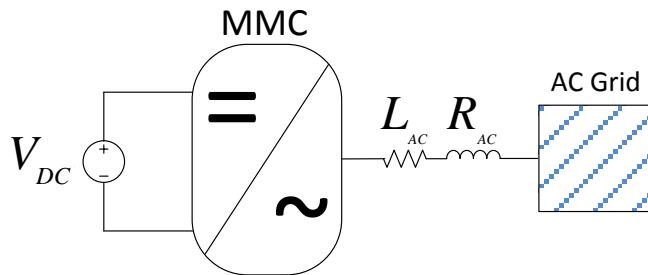
Dynamic Temperature-Dependent Current Limits



Case Study

System Data

AC System Data	
V_{AC} (kV)	15
f (Hz)	50
MMC and DC System Data	
V_{DC} (kV)	30
#SM	10
V_{cap} (V)	3000
f_c (Hz)	1000
IGBT Data	
Model	ABB 5SNA 0650J450300
V_{CE} (V)	4500
I_{CE} (A)	650

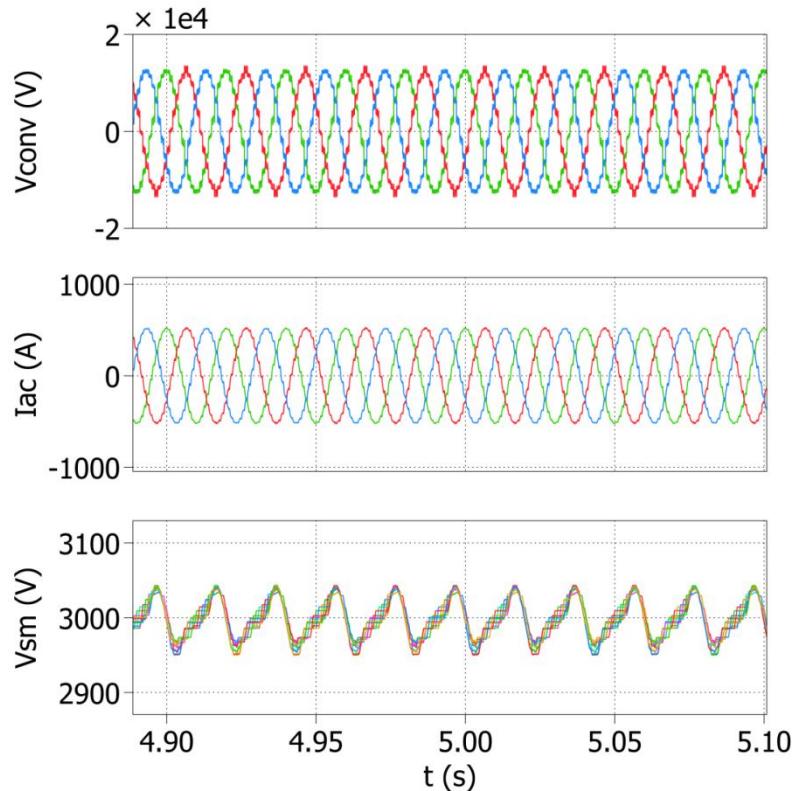


$$\left\{ \begin{array}{l} T_{\max}^J = 85 \text{ } ^\circ\text{C} \\ I_{\lim}^0 = 650 \text{ A} \\ k = 16.25 \text{ A/}^\circ\text{C} \end{array} \right.$$



Results

I. Operational Quantities



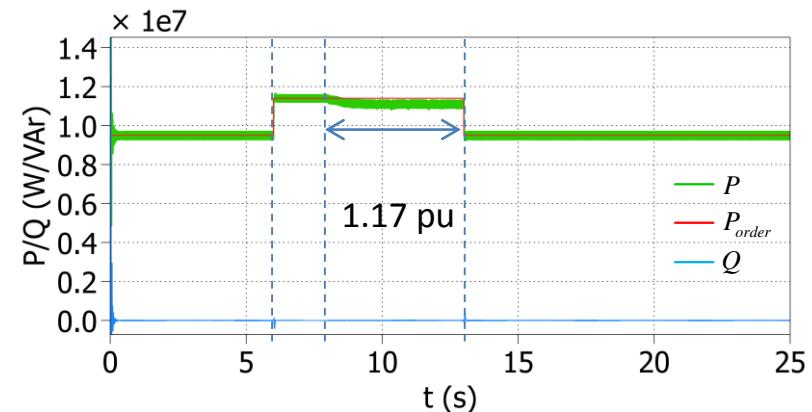
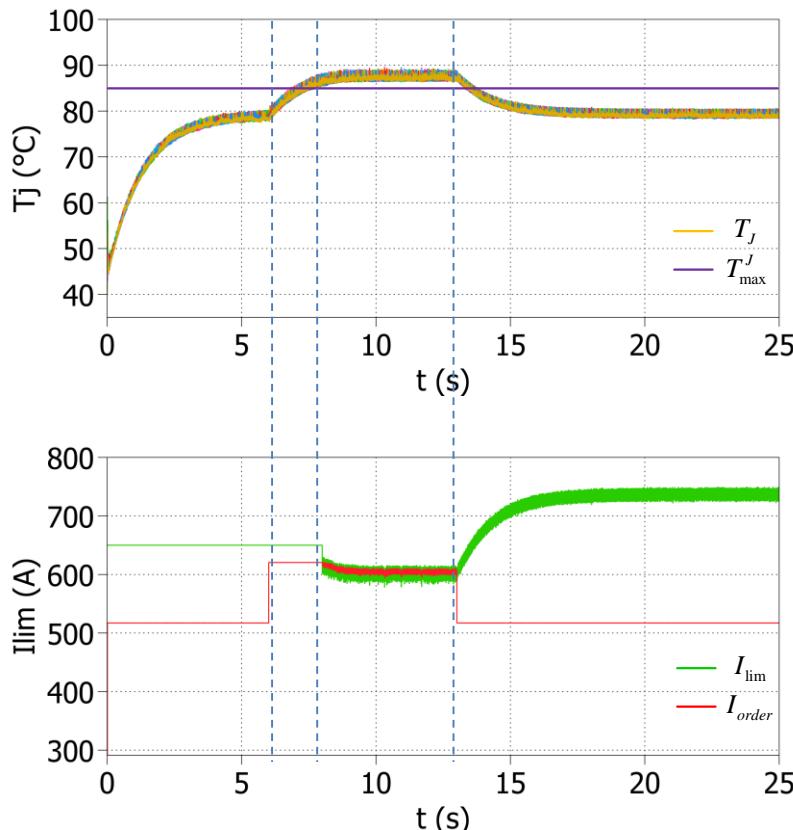
System Dynamics:

- P^* : $9.5 \rightarrow 11.4 \text{ MW}$ ($1 \rightarrow 1.2 \text{ pu}$) @ 6s
- CLM activated @ 8s
- P^* : $11.4 \rightarrow 9.5 \text{ MW}$ ($1.2 \rightarrow 1 \text{ pu}$) @ 13s



Results

II. Dynamic Temperature-Dependent Current Limits



Extension of power transmission capability
+
Respect of electrical and thermal limits
=

Seamless power support to an unbalanced grid



Conclusions & Future Work

- I. Proposed strategy to control the current limits with sensitivity to semiconductors junction temperature;
- II. Transmission capacity can be dynamically controlled, while respecting electrical and thermal constraints, enabling the support to grids with power imbalance;
- III. Operation under fault conditions (not shown) was verified and confirms the validity of the proposed control;
- IV. Experimental validation is on its way.



Thank you for your attention!

